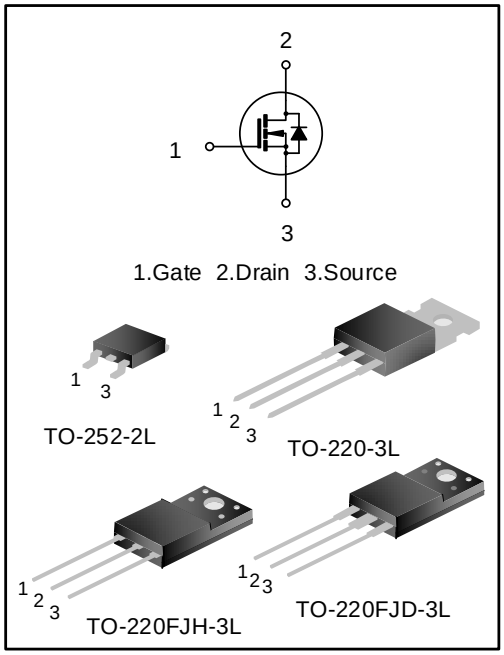
14A, 650V SUPER JUNCTION MOS POWER TRANSISTOR

DESCRIPTION

SVSP65R280FJD(FJH)(D)(T)D4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.



FEATURES

- 14A, 650V, $R_{DS(on)(typ.)}$=0.24Ω@V_{GS}=10V
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- High peak current capability
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant

KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}@$T_{J.max}$	700	V
$V_{GS(th)}$	2.5~4.5	V
$R_{DS(on),max.}$	0.28	Ω
$I_{D.pulse}$	56	A
$Q_{g.typ.}$	26	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVSP65R280FJDD4	TO-220FJD-3L	P65R280D4	Halogen free	Tube
SVSP65R280FJHD4	TO-220FJH-3L	P65R280D4	Halogen free	Tube
SVSP65R280DD4TR	TO-252-2L	P65280D4	Halogen free	Tape & Reel
SVSP65R280TD4	TO-220-3L	P65R280D4	Halogen free	Tube

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, T_J=25°C)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Gate-source Voltage (Static)	V_{GS}	--	-20	--	20	V
Gate-source Voltage (Dynamic)	V_{GS}	AC(f>1Hz)	-30	--	30	V
Drain Current	I_D	T_C=25°C	--	--	14	A
		T_C=100°C	--	--	8.8	A
Drain Current Pulsed (Note 1)	I_{DM}	T_C=25°C	--	--	56	A
Power Dissipation (TO-220FJD-3L) (TO-220FJH-3L) (Note 2)	P_D	T_C=25°C	--	--	24	W
Power Dissipation (TO-252-2L) (Note 2)	P_D	T_C=25°C	--	--	109	W
Power Dissipation (TO-220-3L) (Note 2)	P_D	T_C=25°C	--	--	133	W
Single Pulsed Avalanche Energy	E_{AS}	L=79mH, V_{DD}=100V, R_G=25Ω, starting temperature T_J=25°C	--	--	307	mJ
Single Pulsed Current	I_{AS}	--	--	--	2.6	A
Reverse Diode dv/dt	dv/dt	V_{DS}=0~400V, I_{SD}<=I_S, T_J=25°C	--	--	15	V/ns
MOSFET dv/dt Ruggedness	dv/dt	V_{DS}=0~480V	--	--	50	V/ns
Operation Junction Temperature Range	T_J	--	-55	--	150	°C
Storage Temperature Range	T_{stg}	--	-55	--	150	°C
Continuous Diode Forward Current	I_S	T_C=25°C, integral reverse P-N junction diode in the MOSFET	--	--	14	A
Diode Pulse Current	$I_{S,pulse}$		--	--	56	A
Maximum Diode Commutation Speed	di/dt	V_{DS}=0~400V, I_{SD}<= I_S, T_J=25°C	--	--	500	A/μs

THERMAL CHARACTERISTICS

Table1. TO-220FJD-3L/ TO-220FJH-3L (SVSP65R280FJD/FJHD4)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	5.2	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.5	°C/W
Soldering Temperature (in line)	T_{sold}	15^{+2}_{-0} sec, 1time	--	--	260	°C

Table 2. TO-252-2L (SVSP65R280DD4)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	1.15	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.0	°C/W
Soldering Temperature (SMD)	T_{sold}	Reflow soldering: 10±1sec, 3times	--	--	260	°C

Table 3. TO-220-3L (SVS65R280TD4) thermal characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	0.94	°C/W
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	62.5	°C/W
Soldering Temperature (in line)	T_{sold}	15^{+2}_{-0} sec, 1time	--	--	260	°C

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED,T_J=25°C)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA	650	--	--	V
Drain-source Leakage Current	I_{DSS}	V_{DS}=650V, V_{GS}=0V, T_J=25°C	--	--	1.0	μA
		V_{DS}=650V, V_{GS}=0V, T_J=125°C	--	1.0	--	
Gate-source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V	--	--	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS}, I_D=250μA	2.5	--	4.5	V
Static Drain-source On State Resistance	$R_{DS(on)}$	V_{GS}=10V, I_D=7.0A, T_J=25°C	--	0.24	0.28	Ω
		V_{GS}=10V, I_D=7.0A, T_J=150°C	--	0.55	--	
Gate Resistance	R_G	f=1MHz	--	3.0	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	f=1MHz, V_{GS}=0V, V_{DS}=100V	--	920	--	pF
Output Capacitance	C_{oss}		--	41	--	
Reverse Transfer Capacitance	C_{rss}		--	1.0	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=325V, V_{GS}=10V, R_G=24Ω, I_D=14A (Notes 3, 4)	--	19	--	ns
Turn-on Rise Time	t_r		--	44	--	
Turn-off Delay Time	$t_{d(off)}$		--	68	--	
Turn-off Fall Time	t_f		--	36	--	
Total Gate Charge	Q_g	V_{DD}=520V, V_{GS}=10V, I_D=14A (Notes 3, 4)	--	26	--	nC
Gate-source Charge	Q_{gs}		--	7.2	--	
Gate-drain Charge	Q_{gd}		--	12	--	
Gate-plateau Voltage	$V_{plateau}$		--	6.8	--	V

Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Diode Forward Voltage	V_{SD}	I_S=14A, V_{GS}=0V	--	--	1.4	V
Reverse Recovery Time	T_{rr}	I_S=14A, V_{GS}=0V, V_R=50V, dI_F/dt=100A/μs (Note 3)	--	266	--	ns
Reverse Recovery Charge	Q_{rr}		--	3.4	--	μC
Reverse Recovery Peak Current	I_{rrm}		--	26	--	A

Notes:

1. Pulse time 5μs;
2. The dissipation power will change with temperature, derating above 25°C: .20W/°C(TO-220FJD-3L)(TO-220FJH-3L)/0.87W/°C(TO-252-2L)/1.06W/°C (TO-220-3L);
3. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

Figure 1. Output Characteristics

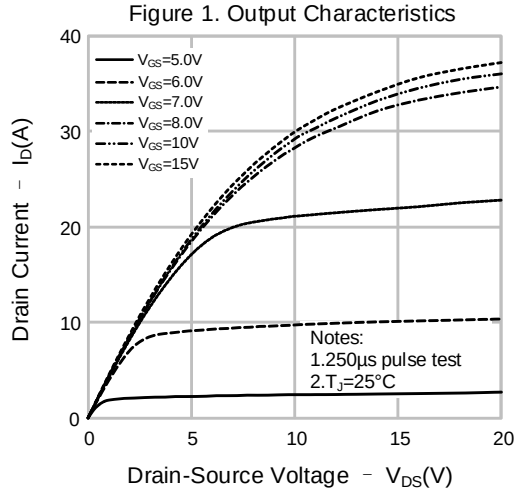


Figure 2. Output Characteristics

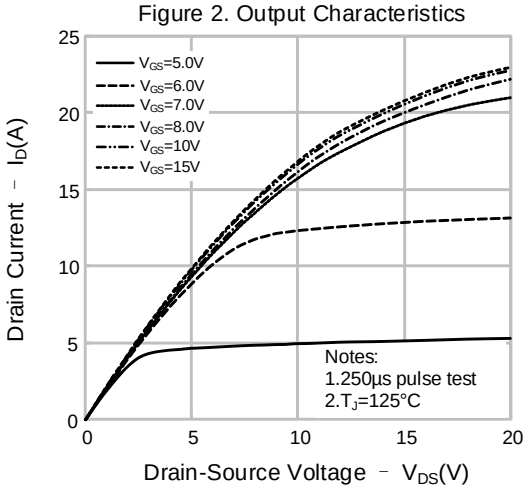


Figure 3. Transfer Characteristics

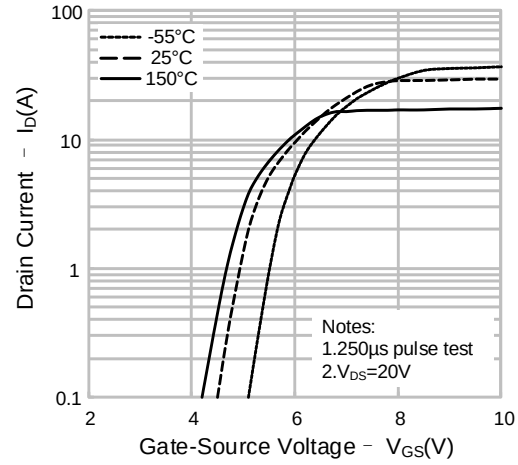


Figure 4. On-Resistance Variation vs. Drain Current

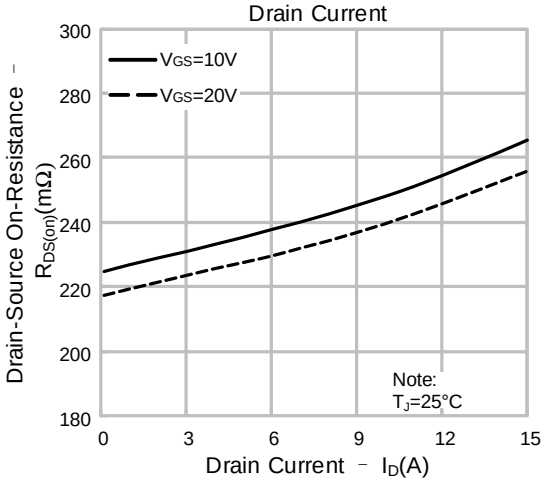


Figure 5. On-Resistance Variation vs. Drain Current

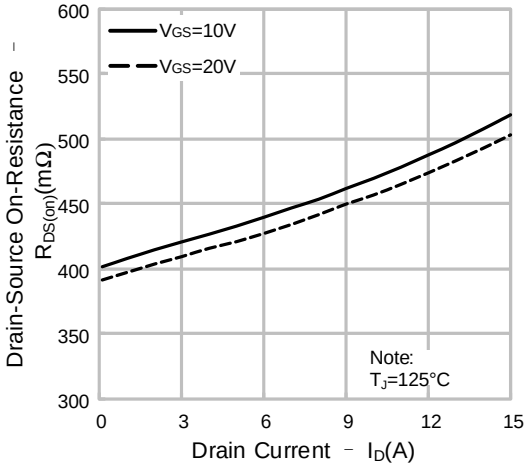
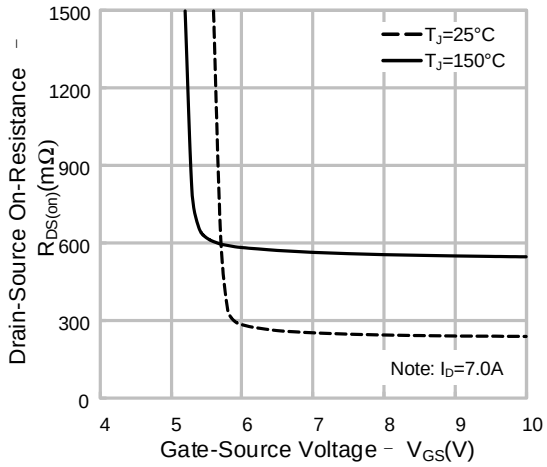


Figure 6. On-Resistance Variation vs. Gate-Source Voltage



TYPICAL CHARACTERISTICS (CONTINUED)

Figure 7. Gate-source Threshold Voltage vs. Temperature

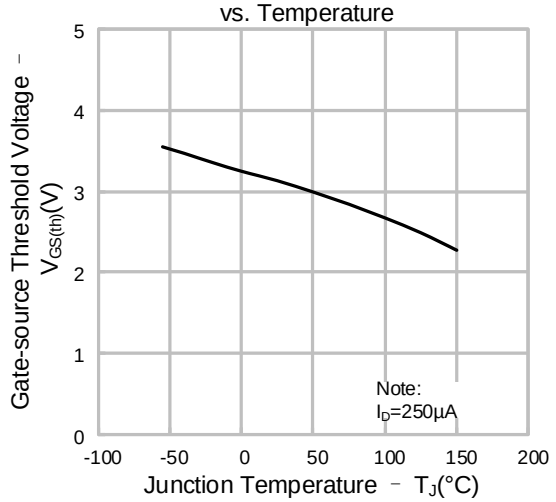


Figure 8. Body Diode Forward Voltage Variation vs. Source Current and Temperature

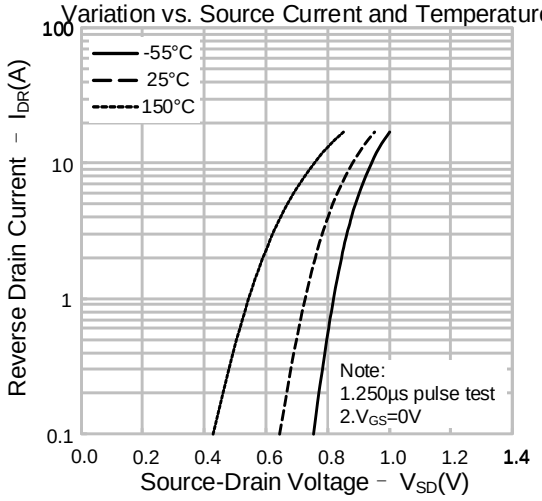


Figure 9. Capacitance Characteristics

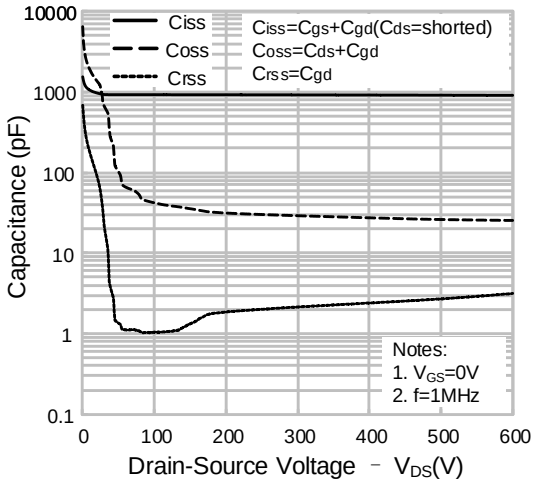


Figure 10. Gate Charge Characteristics

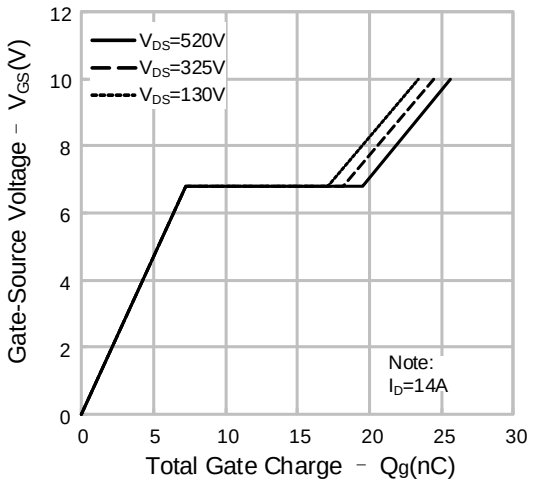


Figure 11. Breakdown Voltage Variation vs. Temperature

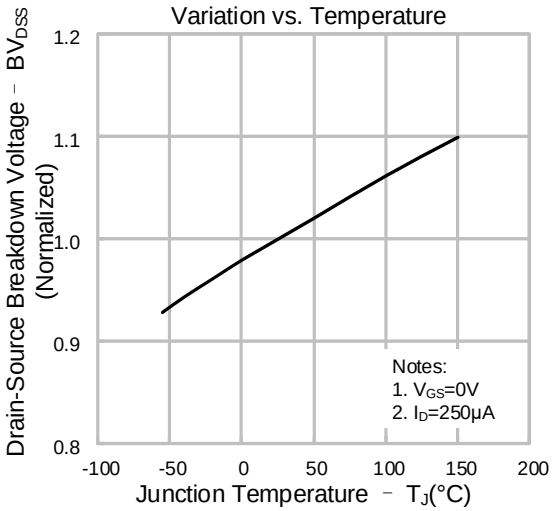
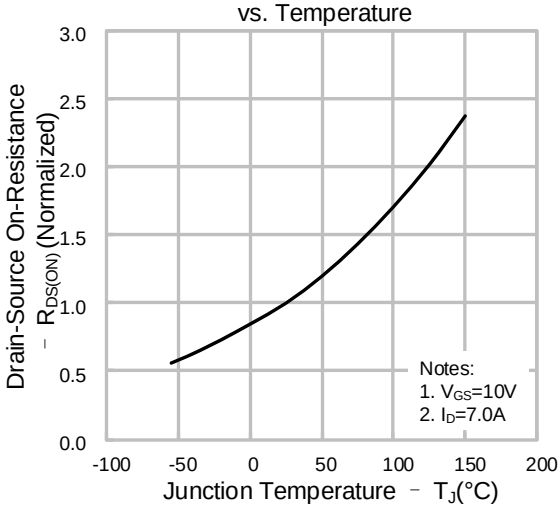


Figure 12. On-resistance Variation vs. Temperature



TYPICAL CHARACTERISTICS (CONTINUED)

Figure 13-1. Max. Safe Operating Area
(SVSP65R280FJD/FJHD4)

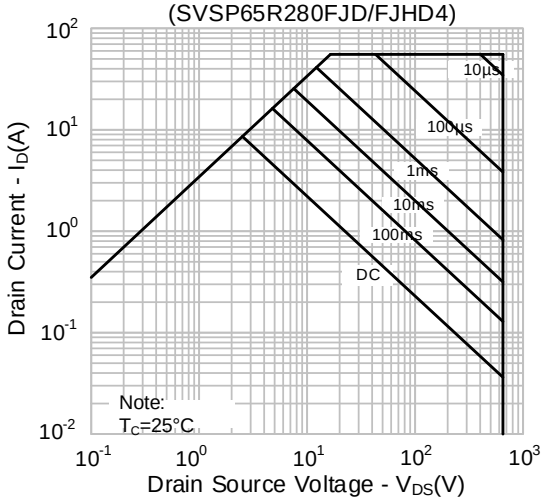


Figure 13-2. Max. Safe Operating Area
(SVSP65R280DD4)

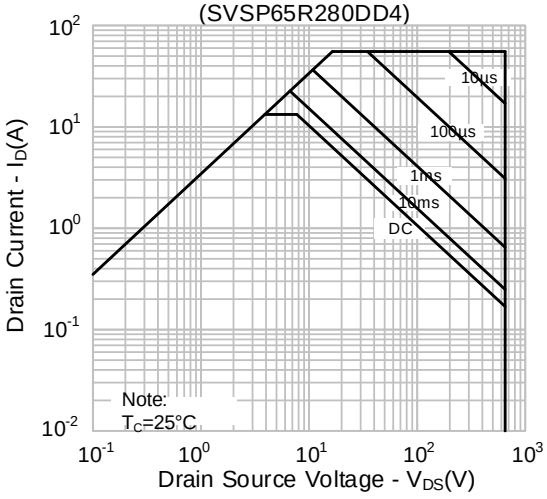


Figure 13-3. Max. Safe Operating Area
(SVSP65R280TD4)

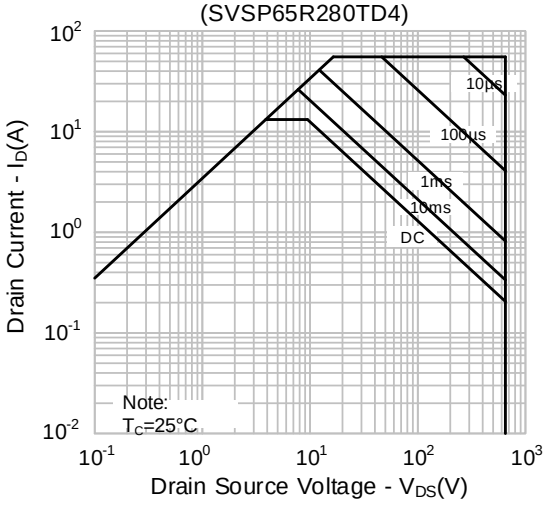


Figure 14-1. Power Dissipation vs. Temperature
(SVSP65R280FJD/FJHD4)

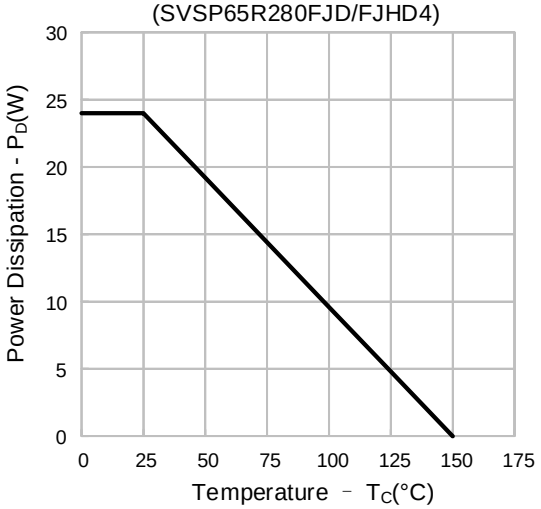


Figure 14-2. Power Dissipation vs. Temperature
(SVSP65R280DD4)

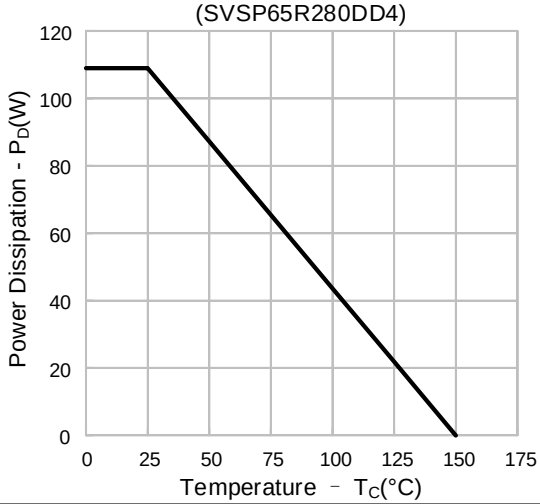
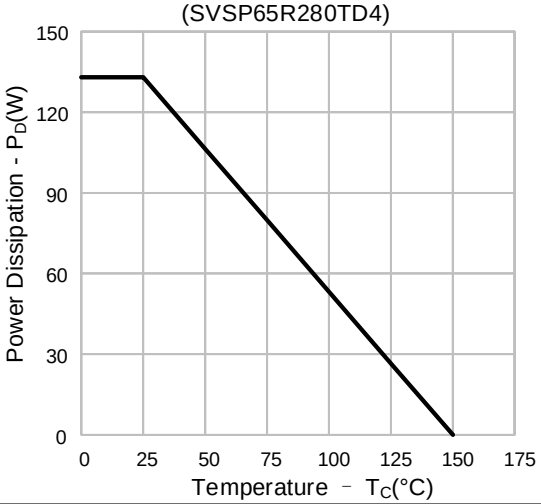


Figure 14-3. Power Dissipation vs. Temperature
(SVSP65R280TD4)



TYPICAL CHARACTERISTICS (CONTINUED)

Figure 15. Drain Current vs. Case Temperature

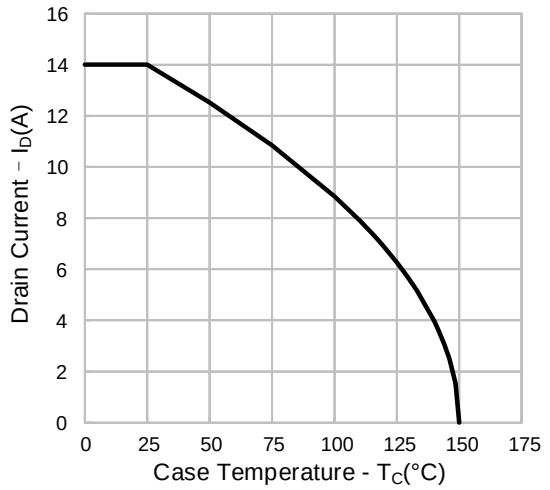


Figure 16-1. Transcient Thermal Impedance vs. On-pulse Duration(SVSP65R280FJD/FJHD4)

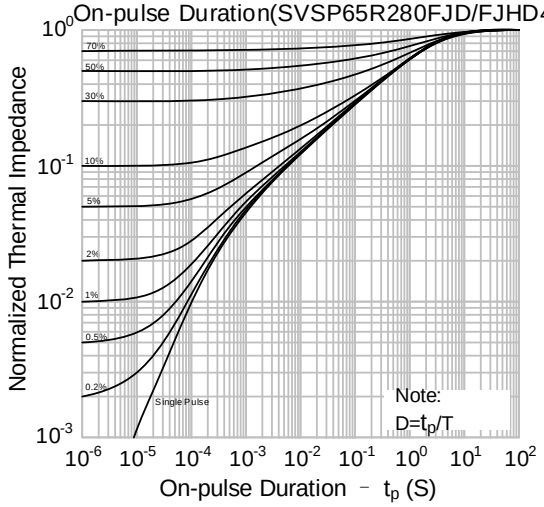


Figure 16-2. Transcient Thermal Impedance vs. On-pulse Duration(SVSP65R280DD4)

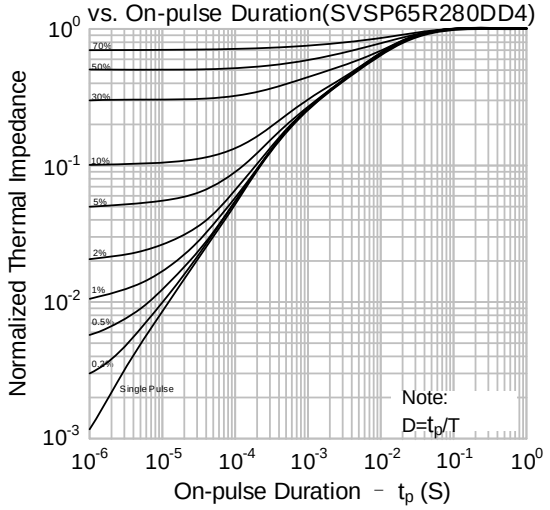
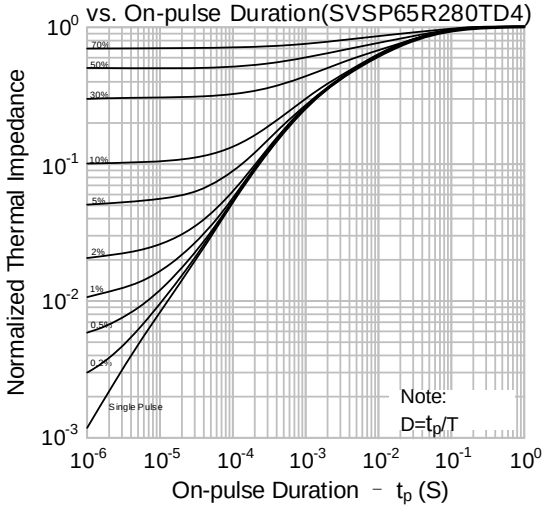
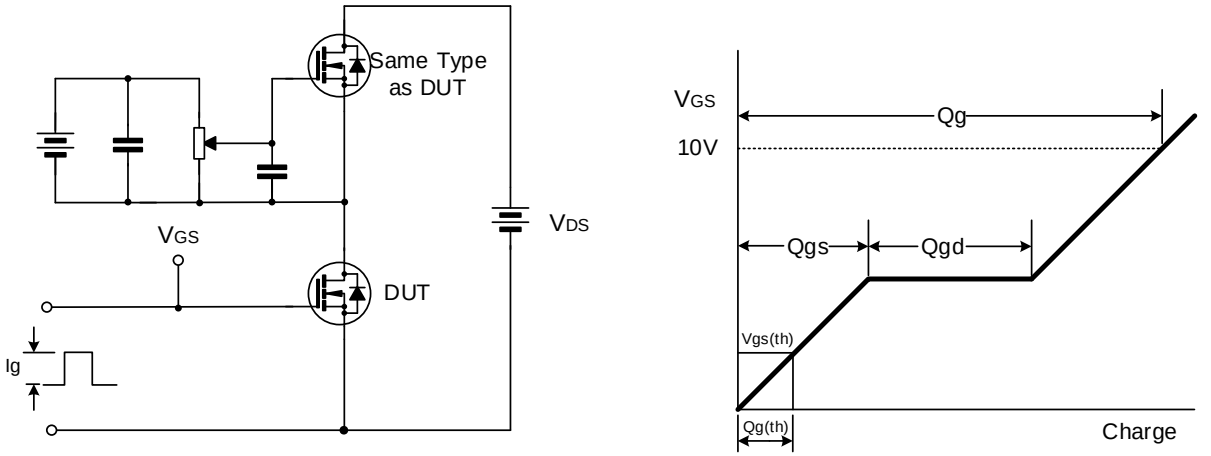


Figure 16-3. Transcient Thermal Impedance vs. On-pulse Duration(SVSP65R280TD4)

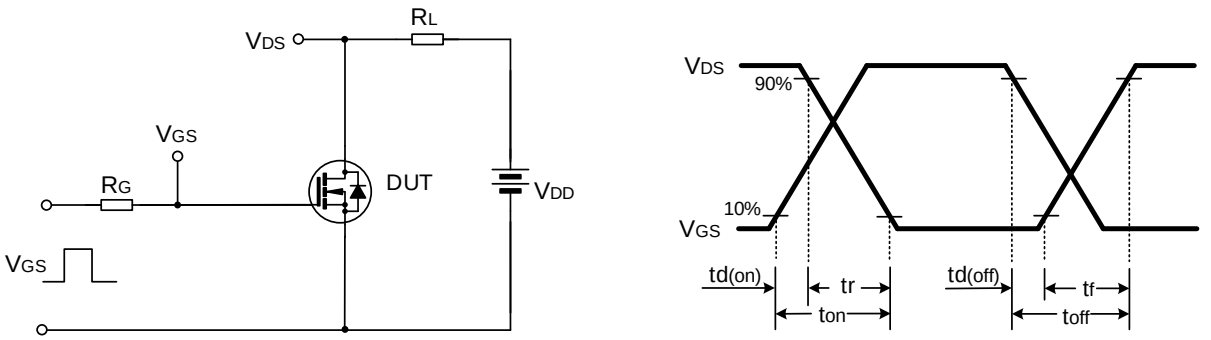


TYPICAL TEST CIRCUIT

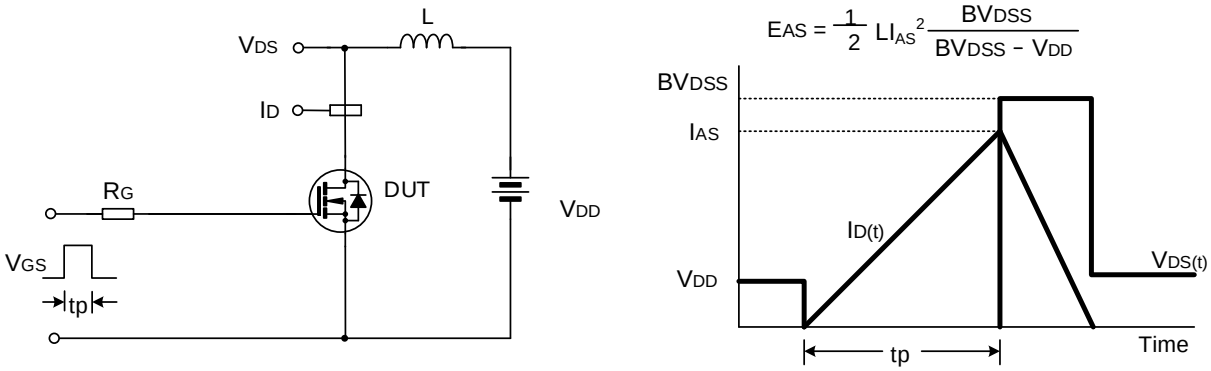
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



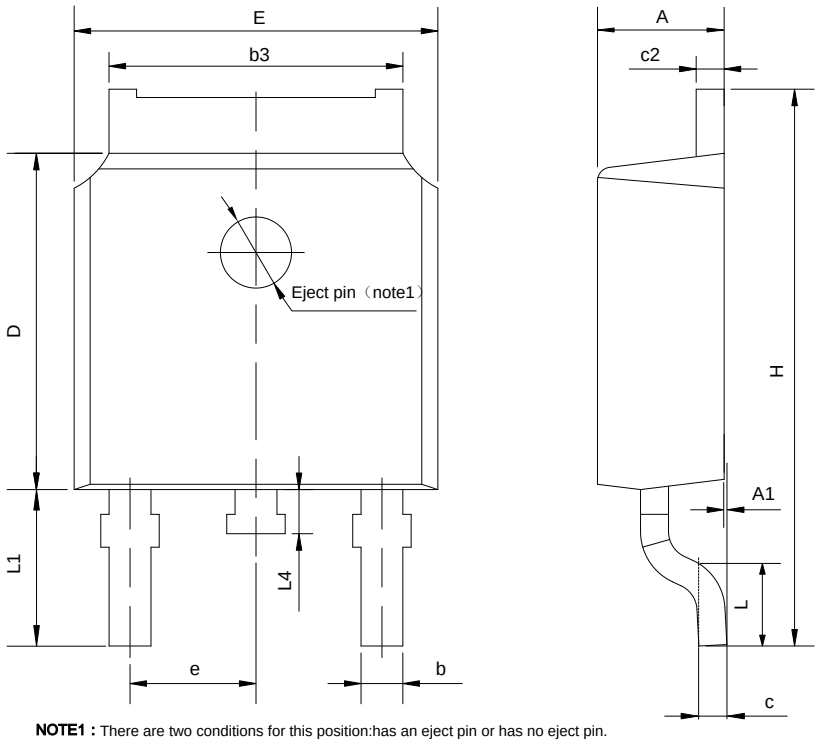
Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE

TO-252-2L

UNIT: mm

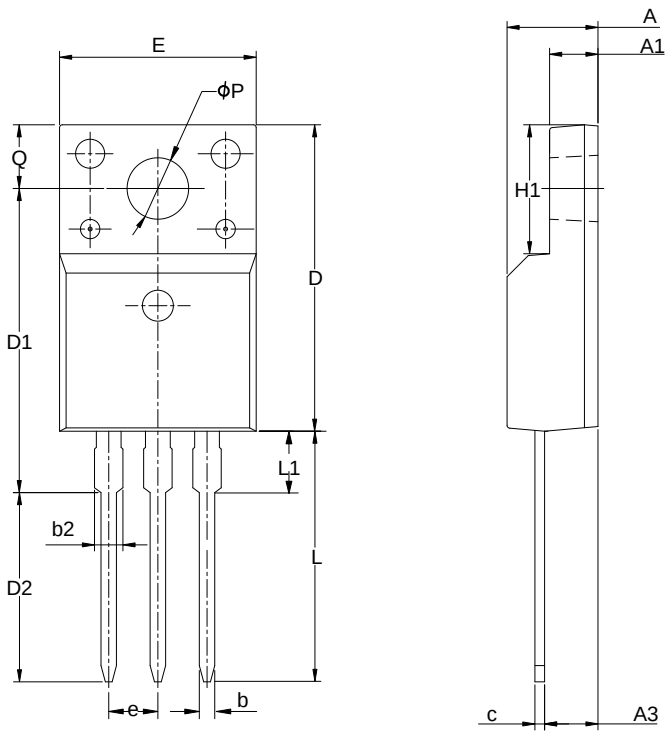


SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	2.10	2.30	2.50
A1	0	—	0.127
b	0.66	0.76	0.89
b3	5.10	5.33	5.46
c	0.45	—	0.65
c2	0.45	—	0.65
D	5.80	6.10	6.40
E	6.30	6.60	6.90
e	2.30TYP		
H	9.60	10.10	10.60
L	1.40	1.50	1.70
L1	2.90REF		
L4	0.60	0.80	1.00

NOTE1 : There are two conditions for this position:has an eject pin or has no eject pin.

TO-220FJD-3L

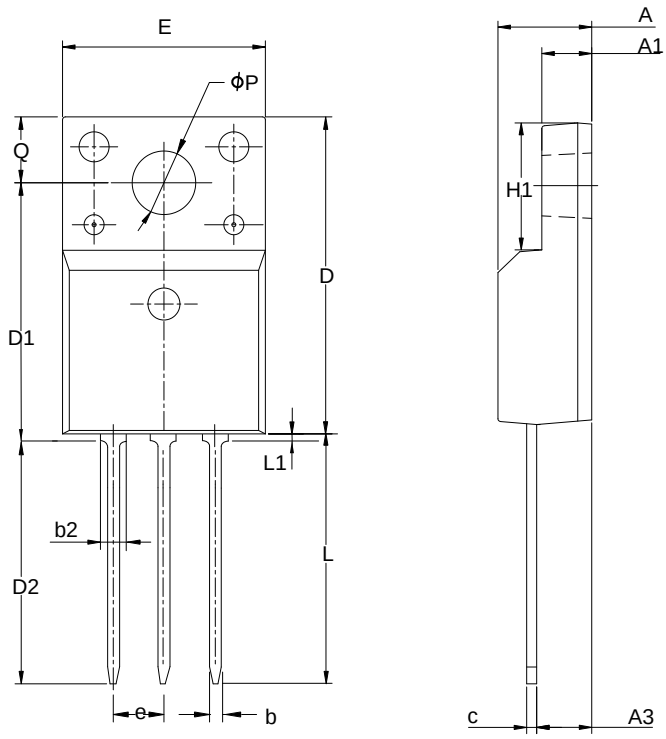
UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e	2.54BSC		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
ϕP	3.00	3.18	3.40
Q	3.05	3.30	3.55

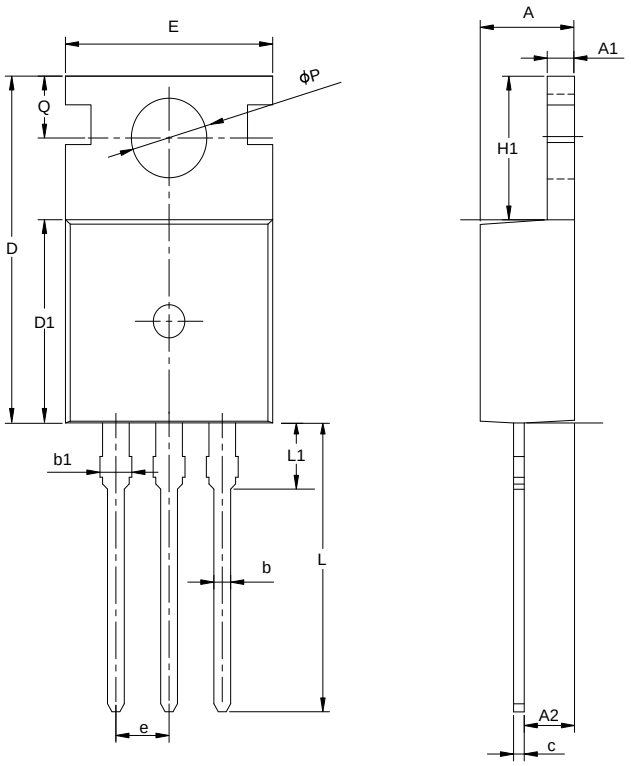
PACKAGE OUTLINE(CONTINUED)

TO-220FJH-3L **UNIT: mm**



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.80
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	12.87	13.07	13.27
D2	12.28	12.48	12.68
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	0.85
ϕP	3.00	3.18	3.40
Q	3.05	3.30	3.55

TO-220-3L **UNIT: mm**



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.30	4.50	4.70
A1	1.00	1.30	1.50
A2	1.80	2.40	2.80
b	0.60	0.80	1.00
b1	1.00	—	1.60
c	0.30	—	0.70
D	15.10	15.70	16.10
D1	8.10	9.20	10.00
E	9.60	9.90	10.40
e	2.54BSC		
H1	6.10	6.50	7.00
L	12.60	13.08	13.60
L1	—	—	3.95
ϕP	3.40	3.70	3.90
Q	2.60	—	3.20

MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Important notice :

1. Silan reserves the right to make changes of this instruction without notice.
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Rev.: 1.1

Revision History:

1. Update TO-220-3L package
2. Modify ordering information
3. Update the parameter and curve

Rev.: 1.0

Revision History:

1. First release